

Dual Switching Diode BAV70T, NSVBAV70T

ANODE O 1 CATHODE ANODE ANODE

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit
Reverse Voltage	V_R	100	Vdc
Forward Current	I _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation, FR-4 Board (Note 1) T _A = 25°C	P _D	225	mW
Derated above 25°C		1.8	mW/°C
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ heta JA}$	555	°C/W
Total Device Dissipation, FR-4 Board (Note 2) T _A = 25°C	P _D	360	mW
Derated above 25°C		2.9	mW/°C
Thermal Resistance, Junction–to–Ambient (Note 2)	$R_{\theta JA}$	345	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-4 @ Minimum Pad
- 2. FR-4 @ 1.0 × 1.0 Inch Pad

MARKING DIAGRAM



CASE 463 SOT-416/SC-75 STYLE 3



A4 = Specific Device Code M = Date Code

= Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
BAV70TT1G	SOT-416 (Pb-Free)	3000 / Tape & Reel
NSVBAV70TT1G	SOT-416 (Pb-Free)	3000 / Tape & Reel
NSVBAV70TT3G	SOT-416 (Pb-Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BAV70T, NSVBAV70T

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Reverse Breakdown Voltage (I _(BR) = 100 μAdc)	V _(BR)	100	-	Vdc
Reverse Voltage Leakage Current (Note 3) (V _R = 100 Vdc) (V _R = 50 Vdc)	I _R	- -	1.0 100	μAdc nAdc
Diode Capacitance (V _R = 0, f = 1.0 MHz)	C _D	-	1.5	pF
Forward Voltage $ \begin{aligned} &(I_F=1.0 \text{ mAdc}) \\ &(I_F=10 \text{ mAdc}) \\ &(I_F=50 \text{ mAdc}) \\ &(I_F=150 \text{ mAdc}) \end{aligned} $	V _F	- - - -	715 855 1000 1250	mVdc
Reverse Recovery Time ($I_F = I_R = 10 \text{ mAdc}, R_L = 100 \Omega, I_{R(REC)} = 1.0 \text{ mAdc}$) (Figure 1)	t _{rr}	-	6.0	ns
Forward Recovery Voltage ($I_F = 10 \text{ mAdc}, t_r = 20 \text{ ns}$) (Figure 2)	V_{RF}	_	1.75	V

^{3.} For each individual diode while the second diode is unbiased.

BAV70T, NSVBAV70T

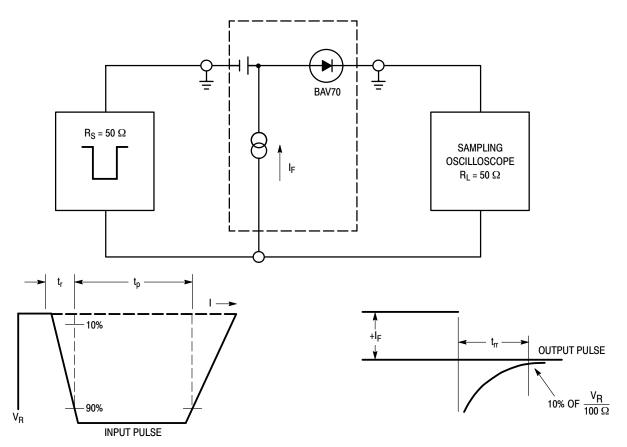
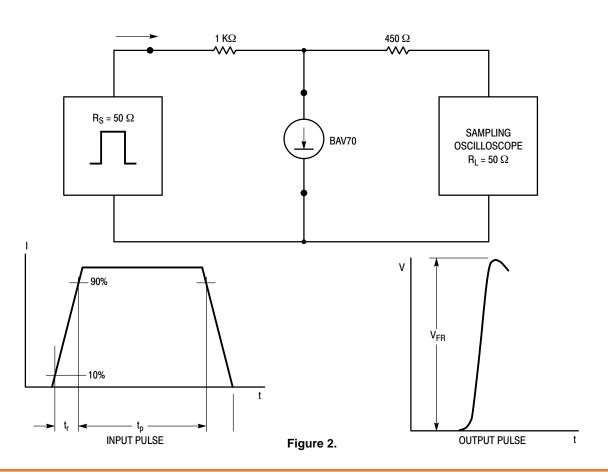
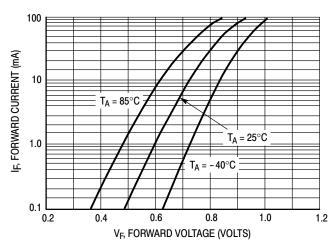


Figure 1. Recovery Time Equivalent Test Circuit



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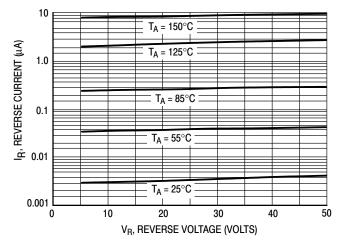


Figure 3. Forward Voltage

Figure 4. Leakage Current

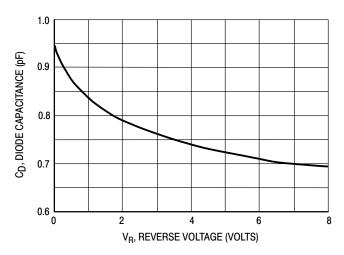


Figure 5. Capacitance

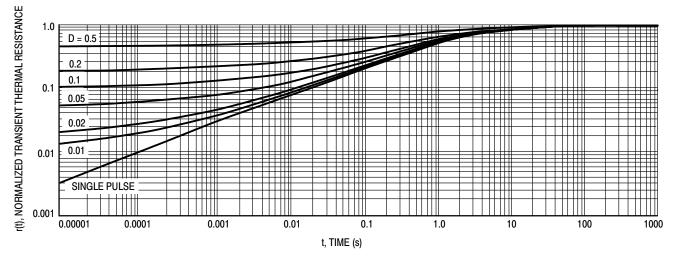


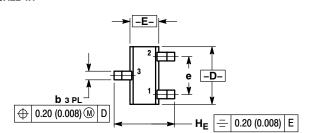
Figure 6. Normalized Thermal Response

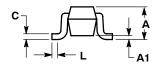




SC-75/SOT-416 **CASE 463 ISSUE G**

DATE 07 AUG 2015





STYLE 1: PIN 1. BASE 2. EMITTER STYLE 2: PIN 1. ANODE 2. N/C 3. CATHODE STYLE 3: PIN 1. ANODE 2. ANODE 3. COLLECTOR 3. CATHODE STYLE 4: STYLE 5: PIN 1. CATHODE 2. CATHODE PIN 1. GATE 2. SOURCE

3. DRAIN

GENERIC MARKING DIAGRAM*

3. ANODE



XX = Specific Device Code Μ = Date Code

= Pb-Free Package

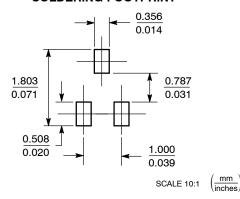
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS				INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.70	0.80	0.90	0.027	0.031	0.035	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
b	0.15	0.20	0.30	0.006	0.008	0.012	
С	0.10	0.15	0.25	0.004	0.006	0.010	
D	1.55	1.60	1.65	0.061	0.063	0.065	
E	0.70	0.80	0.90	0.027	0.031	0.035	
е	1.00 BSC				0.04 BSC)	
L	0.10	0.15	0.20	0.004	0.006	0.008	
He	1.50	1.60	1.70	0.060	0.063	0.067	

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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